

# **K430WQC-V3-F**

# **Product**

Standard LCD Module
480 x RGB x 272 Dots
4.3 inch 16.7M colors TFT display
Wide temperature
With white LED backlight
With touch screen

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1. Document revision history:

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DOCUMENT REVISION	DATE	DESCRIPTION	PREPARED BY	APPROVED BY		
01 02	2010.08.22 2011.05.12	First Release. Revised LED backlight current.	MF Zou XH Dai			
	<u> </u>		1			



## 2. General Description

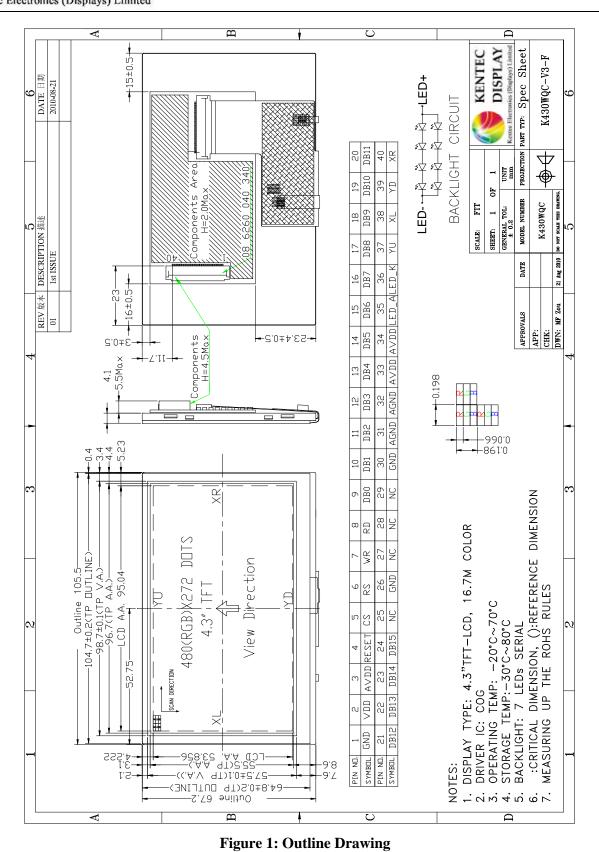
- 4.3"(diagonal), 480 x RGB x 272 dots, 16.7M colors, Normal white TN, TFT LCD module.
- Viewing Direction: 6 o'clock.
- Controller: SSD1963 graphic controller/driver.
- 8080 system 16-bits
- With internal voltage booster.
- Logic voltage: 3.3V (typ.).

## 3. Mechanical Specifications

The mechanical detail is shown in Fig. 1 and summarized in Table 1 below.

#### Table 1

D		G .C. 1.	TT '4
Parameter		Specifications	Unit
Outline dimensions		105.5(W) x 67.2(H) x 9.6(D)	mm
		(Exclude FPC, cables of backlight)	111111
	TP aiew area	96.70(W) x 55.50(H)	mm
	TP view area	98.70(W)x57.50(H)	mm
Color TFT	LCD active area	95.04(W) x 53.856(H)	mm
480xRGBx272	Display format	480 x RGB x 272	dots
	Color configuration	RGB Side-stripes	-
	Dot size	0. 198 (W) x 0.198(RGB)	mm
Weight		TBD	grams





## 4. Interface signals

Table 2: Pin assignment

	~	
Pin No.	Symbol	Description
1	GND	Ground for digital circuit
2	VDD	Power supply for digital circuit ( $VDD = 3.3V$ ).
3	AVDD	Leave it OPEN.
4	RESET	External reset, active low.
5	CS	Chip select, active low.
6	RS	Command/data select.
7	WR	Write control.
8	RD	Read control.
9-24	[DB0-DB15]	16bit data bus
25	NC	NO CONNECT
26	GND	Ground for digital circuit
27-29	NC	NO CONNECT
30	GND	Ground for digital circuit
31-32	AGND	Connect to GND.
33-34	AVDD	Leave it OPEN.
35	LED-A	Anode of LED backlight (13.2V @ 40mA).
36	LED-K	Cathode of LED backlight.
37	YU	
38	XL	Terminal for touch panel
39	YD	1 criminar for touch paner
40	XR	



## **5. Absolute Maximum Ratings**

## **5.1** Electrical Maximum Ratings – for IC Only

<u>Table 3: Electrical Maximum Ratings – for IC</u>

Parameter	Symbol	Min.	Max.	Unit	Note
Supply voltage	VCC	-0.3	5.0	V	1
LED forward current	If		50	mA	
LED reverse	Vr		5.0	V	

Note:

- 1.VCC, GND must be maintained.
- 2. The modules may be destroyed if they are used beyond the absolute maximum ratings.

#### **5.2** Environmental Condition

Table 4

Item	Operating temperature (Topr)		Storage temperature (Tstg) (Note 1)		Remark
	Min.	Max.	Min.	Max.	
Ambient temperature	-20°C	+70°C	-30°C	+80°C	Dry
Humidity (Note 1)	80% max. RH for Ta $\leq 40^{\circ}$ C $< 50\%$ RH for $40^{\circ}$ C $< Ta \leq$ Maximum operating temperature				No condensation

Note 1: Product cannot sustain at extreme storage conditions for long time.

## 6. Electrical Specifications

#### **Typical Electrical Characteristics**

At Ta = 25 °C, VCC=IOVCC= 3.3V, GND=0V.

#### Table 5

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply voltage (logic)	VCC-GND		3	3.3	3.6	V
Input signal voltage	VIH		0.8VCC	-	VCC	V
input signal voltage	VIL		0	-	0.2VCC	V
Supply current (Logic & LCD)	ICC	VDD=3.3V	-	15	19	mA
Supply voltage of white LED backlight	VLED	Forward current = 40 mA Number of LED dies = (2x4)	-	13.2	14	V



## 7. Optical Characteristics

Table 7: Optical specifications

Itams		Cymbol	Condition	Sp	ecificatio	ons	Unit	
Items		Symbol	Condition	Min.	Тур.	Max.	Ullit	
Contrast Ra	atio	CR		400	500	-	-	
Response T	ime	$T_R + T_F$		-	35	-	ms	
	Red	$X_R$		(0.598)	(0.618)	(0.638)	ı	
	Reu	$Y_R$		(0.298)	(0.318)	(0.338)	•	
	Green	$X_{G}$		(0.277)	(0.297)	(0.317)	-	
Chromaticity		$Y_{G}$		(0.525)	(0.545)	(0.565)	-	Note
Cinomaticity	Blue	$X_{B}$		(0.114)	(0.134)	(0.154)	-	
		Y <sub>B</sub>		(0.120)	(0.140)	(0.160)	-	
	White	$X_{\mathrm{W}}$		(0.283)	(0.303)	(0.323)	-	
	wille	$Y_{W}$		(0.320)	(0.340)	(0.360)	-	
Viowing angle	Hor.	$\phi 1 + \phi 2$	Center	100	110	-	dog	
Viewing angle	Ver.	$\theta 1 + \theta 2$	CR=10	120	130	-	deg.	
NTSC ratio					51.7		%	

Note 1: Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63

L0: Luminance of gray level 0

CR = CR (10)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note 5.

Note 2: Definition of Response Time (TR, TF):

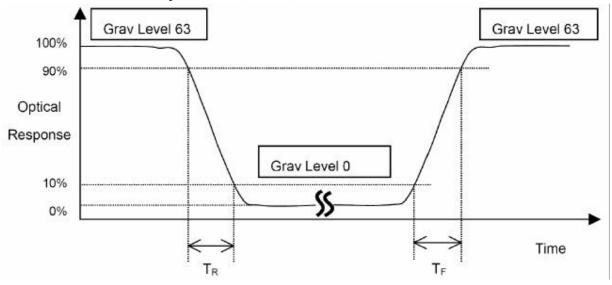
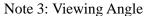


Figure 3



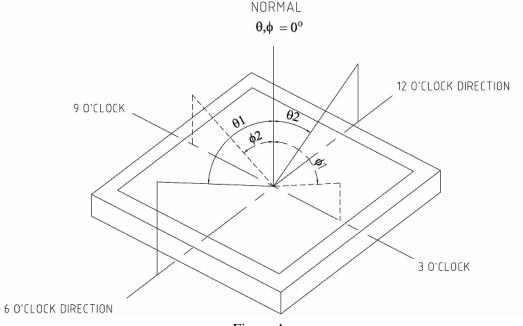


Figure 4

The above "Viewing Angle" is the measuring position with Largest Contrast Ratio; not for good image quality. View Direction for good image quality is 6 O'clock. Module maker can increase the "Viewing Angle" by applying Wide View Film.

#### Note 4: Measurement Set-Up:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.

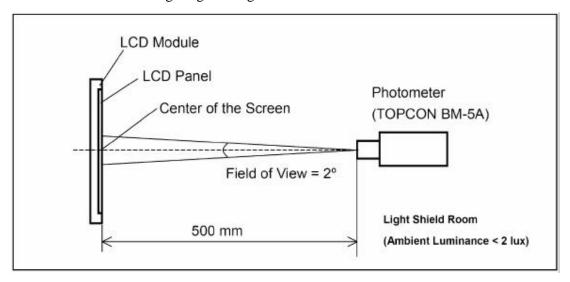


Figure 5



## 8. Reliability Test Item

Test Item	Sample Type	Test Condition	Test result determinant gist
High temperature	Normal temperature	70±3 ;96H	the inspection of
storage	Wide temperature	80±3 ;96H	appearance and function
Low temperature	Normal temperature	-20±3 ;120H	character.
storage	Wide temperature	-30±3 ;120H	
High temperature	Normal temperature	50 ±3 ,90%±3%RH;96H	
/humidity storage	Wide temperature	60 ±3 ,90%±3%RH;96H	
High temperature	Normal temperature	60±3 ;96H	no objection of the function
operation	Wide temperature	70±3 ;96H	character; no fatal objection of
Low temperature	Normal temperature	0±3 ;96H	the appearance.
operation	Wide temperature	-20±3 ;96H	
High temperature	Normal temperature	40 ±3 ,90%±3%RH;96H	
/humidity operation	Wide temperature	50 ±3 ,90%±3%RH;96H	
Temperature Sh	Normal temperature	-20±3 ,30min? 70±3 ,30	inspect the objections
ock		min;10cycle	appearance, function & the
			whole structure
	Wide temperature	-30±3 ,30min	The inspection of appearance,
		80±3,30min;10cycle	function & the whole structure

### 9. Suggestions for using LCD modules

#### 9.1 Handling of LCM

- 9.1.1. The LCD screen is made of glass. Don't give excessive external shock, or drop from a high place.
- 9.1.2. If the LCD screen is damaged and the liquid crystal leaks out, do not lick and swallow. When the liquid is attach to your hand, skin, cloth etc, wash it off by using soap and water thoroughly and immediately.
- 9.1.3. Don't apply excessive force on the surface of the LCM.
- 9.1.4. If the surface is contaminated ,clean it with soft cloth. If the LCM is severely contaminated , use Isopropyl alcohol/Ethyl alcohol to clean. Other solvents may damage the polarizer . The following solvents is especially prohibited: water , ketone Aromatic solvents etc.
- 9.1.5. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 9.1.6. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it



is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.

- 9.1.7. Don't disassemble the LCM.
- 9.1.8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - Be sure to ground the body when handling the LCD modules.
  - Tools required for assembling, such as soldering irons, must be properly grounded.
  - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
  - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- 9.1.9. Do not alter, modify or change the shape of the tab on the metal frame.
- 9.1.10. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- 9.1.11. Do not damage or modify the pattern writing on the printed circuit board.
- 9.1.12. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector
- 9.1.13. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- 9.1.14. Do not drop, bend or twist LCM.

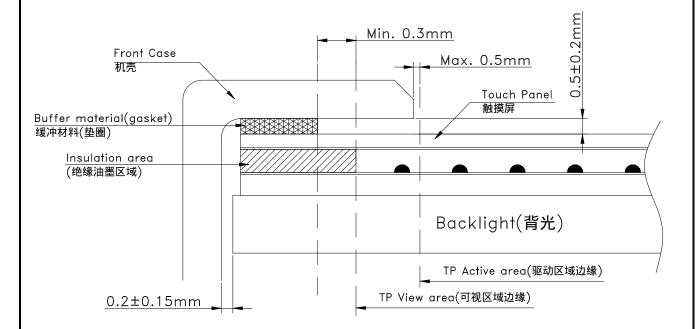
#### 9.2 Cautions for installing and assemably if the module with Touch Panel

- 9.2.1. Use a buffer material (Gasket) between the touch panel and Front-case to protect damage and wrong operating. The dimension of the buffer material's edge between the TP V.A. edge is Min. 0.3mm.
- 9.2.2. We recommend to design a case that it can't over the boundary of the active area Max. 0.5mm in order to prevent an operation at outside of the active area which can't guarantee the specified durability, because operation at the outside of the active area cause serious damage of a transparent.
- 9.2.3. When design case for installing Module, you would consider give a distance about  $0.2 \pm 0.15$ mm



between the module edge to case inside.

9.2.4. The corners of the product are not chamfered. When positioning and fixing the product on the case, we sugguest that you would provide a R part on the conner of the case so as not to apply load on the corner of the transparent module.



#### 9.3 Storage

- 9.3.1. Store in an ambient temperature of 5 to 45 °C, and in a relative humidity of 40% to 60%. Don't expose to sunlight or fluorescent light.
- 9.3.2. Storage in a clean environment, free from dust, active gas, and solvent.
- 9.3.3. Store in antistatic container.

## 10. Inspection Standard

This specification is made to be used as the standard acceptance/rejection criteria for Color mobile phone LCM with touch pannel.

#### 10.1 Sample plan and Inspection condition

10.1.1 Sample plan

Sampling plan according to MIL-STD-105E, normal level 2 and based on:

Major defect: AQL 0.65;

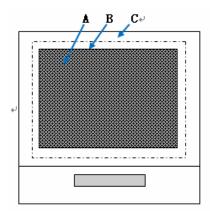


Minor defect: AQL 1.5.

10.1.2 Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45 against perpendicular line.

#### 10.2 Definition of inspection zone in LCD



Inspection zones in an LCD

Zone A: character/Digit area;

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area);

Zone C: Outside viewing area (invisible area after assembly in customer's product);

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product. Defects are classified as major defects and minor defects according to the degree of defectiveness defined herein.

#### 10.3 Major defects and Minor defects

10.3.1 Major defects

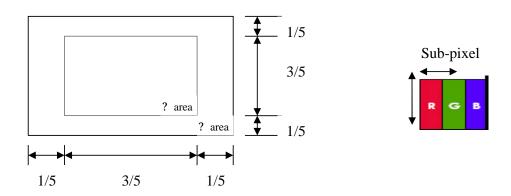
A major defect is a defect that is likely to result in failure, or to reduce the usability of the product for its intended purpose.

- 10.3.1.1 Abnormal operation: modules cannot display normally;
- 10.3.1.2 Line defect;
- 10.3.1.3 There is serious distortion or sharp burr on mechanical housing;
- 10.3.1.4 Glass breakage.
- 10.3.2 Minor defects:

A minor defect is a defect that is not likely to reduce the usability of the product for its intended purpose.

- 10.3.2.1 Dot defect:
- 10.3.2.1.1 Inspection pattern: Full white, full black, red, green and blue screens;
- 10.3.2.1.2 Criteria:(acceptable);





- Note: 1. Dot defect is defined as the defective area of the dot area is larger than 50% of the dot area. And the bright dot defect must be visible through 5% ND filter.
  - 2. Except for the allowed numbers of adjacent dots, the distance between dot defects should be more than 3mm apart.
- 10.3.2.1.3 The definitions of the inner display area and outer display area.

#### 10.4 Inspection standards table:

#### 10.4.1 Major defect

Item No.	Items to be	Inspection Standard	Classification of defects
10.4.1.1	All functional defects	<ol> <li>No display</li> <li>Display abnormally</li> <li>Missing vertical/horizontal segment</li> <li>Short circuit</li> <li>Back-light no lighting, flickering and abnormal lighting.</li> </ol>	Major
10.4.1.2	Missing	Missing component	·
10.4.1.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	
10.4.1.4	linearity	No more than 1.5%	

#### 10.4.2 Cosmetic Defect (spot defect)

Item No	Itemsto be	Inspection Standard	Classification of defects
10.4.2.1	Clear Spots Black and white	For dark/white spot, sizeF is defined as $F = (x + y)/2$	Minor



	Spot defect	Zone		Acceptabl	le Qty	
	Pinhole,	Size(mm)	A	В	С	
	Foreign	F=0.1	Ign	ore		Minor
	Particle,	0.10< F=0.15	2		Ignore	
	polarizer Dirt	0.15< F=0.20	1		ignore	
	DIIt	F > 0.20	0			
		Zone		Acceptabl	le Qty	
		Size(mm)	A	В	C	
10.4.2.2	Clear Spots	F=0.1	Ign			Minor
10.4.2.2	TP Dirt	0.10< F=0.15	2		I am a ma	Minor
		0.15< F=0.25	1		Ignore	
		F > 0.25	0			
	Dim Spots	Zone	Acceptable Qty		e Qty	
	Circle	Size(mm)	A	В	C	
	1 1 1	7				
10 4 2 2	shaped and	F=0.2	Ign	ore		Minon
10.4.2.3	dim edged	0.20< F=0.4	Igno	ore	Ignore	Minor
10.4.2.3				ore	Ignore	Minor
10.4.2.3	dim edged	0.20< F=0.4		ore	Ignore	Minor
10.4.2.3	dim edged	0.20< F=0.4 0.4< F=0.6	2	ore	Ignore	Minor
10.4.2.3	dim edged	0.20< F=0.4 0.4< F=0.6 F> 0.6	2 1 0	ore Acceptabl		Minor
	dim edged defects	0.20< F=0.4 0.4< F=0.6 F> 0.6	2 1 0			
10.4.2.4	dim edged	0.20< F=0.4 0.4< F=0.6 F> 0.6	2 1 0		e Qty	Minor
	dim edged defects	0.20< F=0.4 0.4< F=0.6 F> 0.6 dot =sub-pixel	2 1 0		e Qty	

## 10.4.3 Cosmetic Defect (linear defect)

Item No	Items to be	Inspection Standard					Classification of defects
	Line defect	Si	ze(mm)	Acceptable Qty			
		ect T. (1.)	W(Width)	zone			
	Black line,	L(Length)		A	В	С	
10.4.3.1	White line, Foreign material on polarizer	Ignore	W=0.02	Igr	nore		Minor
		L=3.0	0.02< W=0.03	2		T	
		L=2.0	0.03< W=0.05	1		Ignore	
			W> 0.05	Define as spot defect			
	Foreign Material on TP film	The line can be seen after mobile phone in the operating condition:					
		Size(mm)		Acceptable Qty			
10.4.3.2		L(Length)	W(Width)	zone			
		on (Length)		A	В	C	Minor
		Ignore	W=0.03	Ignore		Ignore	1.211101
		L=3.0	0.03 < W=0.05	3			
			W> 0.05	Define as s	pot defect		



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10.4.3.3	Dim line defect Polarizer &BL scratch	If the scratch can be seen after mobile phone cover assembling or in the operating condition, judge by the line defect of 10.4.3.1. If the scratch can be seen only in non-operating condition or some special angle, judge by the following.  Size(mm)  Acceptable Qty						
		L(Length) W(V		W(Width)		zone		Minor
	TP film	_(=====================================	,, (,, ratil)		A	В	С	1,11101
	scratch	Ignore	W=0.02		Ig	Ignore		
		L=3.0	0.02< W=0.03			2	Ignore	
		L=2.0	0.03< W=0.05		1		1 Ignore	
			W> 0.05		Define as	spot defect		
	Polarize Air bubble	Air bubbles between glass & polarizer						
					Accept	table Qty		
				A		В	С	
10.4.3.4		F=0.2			Ignore		Ignore	Minor
		0.20< F=0.3		2				
		0.3< F=0.5			1			
		F> 0.5	> 0.5		0			

## 10.4.4 Chipping Defect

Item No	Items to be	Inspection Standard			Classification of defects
10.4.4.1	Glass defect	Chips on corner  A:LCD Glass defect  Notes: S=contact pad length Chips on the corner of terminal shall not ITO pad or expose perimeter seal.  B:TP Glass defect	$\begin{array}{c c} X & Y \\ \hline =0.2 & =S \\ \hline \end{array}$ to be allowed to extend to ext	Z Disregard end into the  Z Disregard	Minor



#### 10.4.5 Parts Defect

Item No	Items to be	Inspection Standard	Classification of defects
10.4.5.1	Parts contra position	<ol> <li>Not allow IC and FPC/heat-seal lead width is more than 50% beyond lead pattern.</li> <li>Not allow chip or solder component is off center more than 50% of the pad outline.</li> </ol>	Major
10.4.5.2	SMT	According to the <acceptability assemblies="" electronic="" of="">IPC-A-610C class 2 standard. Component missing or function defect are Major defect, the others are Minor defect.</acceptability>	Major
10.4.5.3	TP Defect	Pattern font: Pattern fonts are clear and symmetrical, pattern fonts filter lightly are allowed; The fort line is not allow to thinner or thicker than 1/3 of normal size, and swing is not more than 0.1mm. the line is smooth and not broken.  Pattern font  2. The wing forward in the side of Visual Area: The length of wing forward inside of the Visual Area: n=0.2mm; Not excess 3 point, and the distance D=20mm.	Major



		Burr  3, Film impression: With operation, must be invisibility. 4, Touch panel knob: if writing function normally, it could be allowed.  TP knob  5, Newton ring Without operation, the color circle of Regularity or Non-regularity from the normal or slope angle of view. 1, Regularity: The area of the newton ring is less than 1/3 area of the touch panel; and no character affected and line distorted after touch panel lightening. It's ok. 2, Non-regularity: The area of the Newton ring is less than the 1/2 area of touch panel with lightening. And no character affected and line  Regular  Irregular  Irregular	
		1 Illumination source flickers when lit.	
10.4.5.4	Backlight elements	2 Spots or scratches that appear when lit must be judged using LCD spot, lines and contamination standards.  3 Backlight doesn't light or color is wrong	Major
10.4.5.5	Soldering	1 No unmelted solder paste may be present on the FPC 2 No cold solder joints, missing solder connections, oxidation or icicle. 3 No short circuits in components on FPC	Major

## 11. Packing (T.B.D.)